## AMENDMENTS TO THE CLAIMS

1. (Currently amended) A resin for a photoresist composition comprising a -CR<sup>1</sup>R<sup>2</sup>OH group only at a terminal of a principal chain of the resin; (a1) a structural unit derived from a (meth)acrylate ester having an acid dissociable, dissolution inhibiting group; and (a2) a structural unit derived from a (meth)acrylate ester having a lactone ring, wherein R<sup>1</sup> and R<sup>2</sup> each represent, independently, an alkyl group, halogen atom, or halogenated alkyl group, and at least one of R<sup>1</sup> and R<sup>2</sup> is an electron attractive group selected from the group consisting of halogen atoms and halogenated alkyl groups.

- (Canceled).
- (Original) A resin for a photoresist composition according to claim 1, wherein said electron attractive group is a fluorine atom or a fluorinated alkyl group.
- 4. (Canceled)
- (Canceled)
- (Canceled)
- 7. (Canceled)
- (Canceled)
- (Currently amended) A resin for a photoresist composition according to claim 8 1, further comprising (a3) a structural unit derived from a (meth)acrylate ester having a hydroxyl group.
- (Previously presented) A resin for a photoresist composition according to claim 1, with a weight average molecular weight of no more than 12,000.

11. (Previously presented) A photoresist composition, comprising a resin for a photoresist composition according to claim 1.

## (Currently amended) A photoresist composition according to claim 11, further comprising;

a resin comprising a -CR<sup>1</sup>R<sup>2</sup>OH group only at a terminal of a principal chain of the resin, wherein R<sup>1</sup> and R<sup>2</sup> each represent, independently, an alkyl group, halogen atom, or halogenated alkyl group, and at least one of R<sup>1</sup> and R<sup>2</sup> is an electron attractive group selected from the group consisting of halogen atoms and halogenated alkyl groups; and an acid generator as a component (B).

- (Original) A photoresist composition according to claim 12, comprising as said component (B), (b-0) an onium salt that comprises a fluorinated alkylsulfonate ion as an anion.
- 14. (Original) A photoresist composition according to claim 12, comprising as said component (B), a sulfonium compound represented by either of general formulas (b-1) and (b-2) shown below:

wherein, X represents an alkylene group of 2 to 6 carbon atoms in which at least one hydrogen atom has been substituted with a fluorine atom; Y and Z each represent, independently, an alkyl group of 1 to 10 carbon atoms in which at least one hydrogen atom has been substituted with a fluorine atom;  $R^1$  to  $R^3$  each represent, independently, an aryl group or an alkyl group, and at least one of  $R^1$  to  $R^3$  is an aryl group.

> (Original) A photoresist composition according to claim 14, further comprising as said component (B), (b-0) an onium salt that comprises a fluorinated alkylsulfonate ion as an anion.

16. (Currently amended) A photoresist composition according to claim 11, further comprising:

a resin comprising a  $-CR^1R^2OH$  group only at a terminal of a principal chain of the resin, , wherein  $R^1$  and  $R^2$  each represent, independently, an alkyl group, halogen atom, or halogenated alkyl group, and at least one of  $R^1$  and  $R^2$  is an electron attractive group selected from the group consisting of halogen atoms and halogenated alkyl groups; and

a nitrogen-containing organic compound.

17. (Currently amended) A method for forming a resist pattern, using a photoresist composition according to claim 11, comprising the steps of:

applying a photoresist composition that comprises a resin comprising a  $\frac{-CR^1R^2OH \text{ group only at a terminal of a principal chain of the resin, wherein } R^1 \text{ and } R^2$  each represent, independently, an alkyl group, halogen atom, or halogenated alkyl group, and at least one of  $R^1$  and  $R^2$  is an electron attractive group selected from the group consisting of halogen atoms and halogenated alkyl groups to a surface of a substrate; performing selective exposure through a desired mask pattern; and performing developing to form a resist pattern.

- 18. (Canceled)
- 19. (Canceled)
- 20. (Canceled)
- 21. (Canceled)

22. (Canceled)

23. (Canceled)

(Canceled) 24.